
PXI-5114

Specifications

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PXI-5114 Specifications

Definitions

Warranted specifications describe the performance of a model under stated operating conditions and are covered by the model warranty. Warranted specifications account for measurement uncertainties, temperature drift, and aging. Warranted specifications are ensured by design or verified during production and calibration.

Characteristics describe values that are relevant to the use of the model under stated operating conditions but are not covered by the model warranty.

- **Typical** specifications describe the performance met by a majority of models.
- **Nominal** specifications describe an attribute that is based on design, conformance testing, or supplemental testing.
- **Measured** specifications describe the measured performance of a representative model.

Conditions

Specifications are valid under the following conditions unless otherwise noted.

- All filter settings
- All impedance selections
- Sample clock set to 250 MS/s

Warranted specifications are valid under the following conditions unless otherwise noted.

- Temperature range of 0 °C to 55 °C
- The PXI-5114 is warmed up for 15 minutes at ambient temperature
- Self-calibration is completed after warm-up period

- Calibration cycle is maintained
- The PXI/PXI Express chassis fan speed is set to HIGH, the foam fan filters are removed if present, and the empty slots contain PXI chassis slot blockers and filler panels. For more information about cooling, refer to the **Maintain Forced-Air Cooling Note to Users** available at ni.com/manuals.
- External calibration is performed at $23\text{ }^{\circ}\text{C} \pm 3\text{ }^{\circ}\text{C}$

Vertical

Analog Input

Number of channels	Two (simultaneously sampled)
Input type	Referenced single-ended
Connectors	BNC

Impedance and Coupling

Input impedance 50 Ω 50 $\Omega \pm 1.5\%$ 1 M Ω 1 M $\Omega \pm 1\%$ in parallel with a nominal capacitance of 26 pF	
Input coupling	AC ^[1] , DC, GND

Voltage Levels

Input Range (V_{pk-pk})	Vertical Offset Range (V)	
	50 Ω Input	1 M Ω Input
0.04 V	± 0.8	± 0.8
0.1 V		

Input Range (V _{pk-pk})	Vertical Offset Range (V)	
	50 Ω Input	1 M Ω Input
0.2 V		
0.4 V		
1 V	± 6.5	± 8.0
2 V	± 6.0	
4 V	± 5.0	
10 V	± 2.0	± 30
20 V	—	± 25
40 V	—	± 15

Table 1. Full-Scale (FS) Input Range and Programmable Vertical Offset Range

Maximum input overload	
50 Ω	7 V RMS with Peaks ≤ 10 V
1 M Ω	Peaks ≤ 35 V

Accuracy

Resolution	8 bits
DC accuracy ^[2]	$\pm[(1.5\% \times \mathbf{Reading} - \mathbf{Vertical Offset} + 2\% \text{ of } \mathbf{Vertical Offset} + 0.3\% \text{ of } \mathbf{FS} + 200 \mu\text{V})]$, warranted
DC drift	$\pm(0.03\% \times \mathbf{Reading} + 0.06\% \text{ of } \mathbf{FS} + 40 \mu\text{V})$ per °C, nominal
Crosstalk^[3]	
At 10 MHz input frequency	≤ -60 dB
At 100 MHz input frequency	≤ -45 dB

Bandwidth and Transient Response

Bandwidth (-3 dB)

0.04 V_{pk-pk} input range 100 MHz, warranted

All other input ranges 125 MHz, warranted

Rise/fall time

0.04 V_{pk-pk} input range 3.5 ns

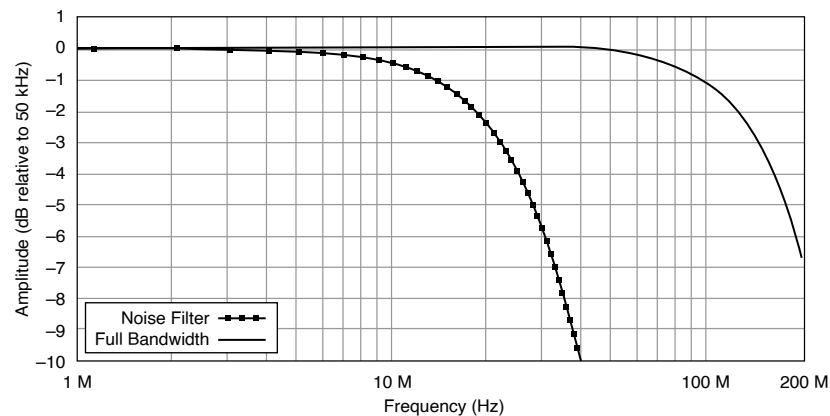
All other input ranges 2.8 ns

Bandwidth-limiting filter 20 MHz noise filter

AC coupling^[4] cutoff (-3 dB) 12 Hz

Passband flatness^[5] ±1 dB up to 50 MHz, warranted

Figure 1. PXI-5114 Frequency Response, Measured



Spectral Characteristics

Spurious-free dynamic range (SFDR) ^[6]	58 dBc
Total harmonic distortion (THD) ^[6]	-58 dBc
Effective number of bits (ENOB), calculated^[6]	
0.04 V _{pk-pk} input range	6.2
All other input ranges	7.2
Signal to noise and distortion (SINAD)^[6]	
0.04 V _{pk-pk} input range	38 dB
All other input ranges	44 dB

Noise

Input Range (V _{pk-pk})	Full Bandwidth	20 MHz Filter Enabled
0.04 V	0.45% FS	0.28% FS
All other input ranges	0.28% FS	0.28% FS

Table 2. RMS Noise^[7]

Horizontal

Sample Clock

Sources	
Internal ^[8]	Onboard clock (internal VCXO)

External	CLK IN (front panel SMB connector)
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Onboard Clock (Internal VCXO)

Sample rate range	
Real-time sampling (single-shot) ^[9]	3.815 kS/s to 250 MS/s
Random interleaved sampling (RIS)	250 MS/s to 5 GS/s in 250 MS/s increments
Timebase frequency^[10]	
250 MHz	
Timebase accuracy	
Not phase-locked to Reference clock	±25 ppm, warranted
Phase-locked to Reference clock	Equal to the Reference clock accuracy
Sample clock delay range	
±1 Sample clock period	
Sample clock delay resolution	
≤20 ps	

External Sample Clock

Source	CLK IN (front panel SMB connector)
Frequency range ^[11]	50 MHz to 250 MHz
Duty cycle tolerance	45% to 55%

Phase-Locked Loop (PLL) Reference Clock

Sources	PXI_CLK10 (backplane connector) CLK IN (front panel SMB connector)
Frequency range ^[12]	5 MHz to 20 MHz in 1 MHz increments Default: 10 MHz
Duty cycle tolerance	45% to 55%
Exported Reference clock destinations	PFI <0..1> (front panel 9-pin mini-circular DIN connector) PXI_Trig <0..7> (backplane connector)

External Sample Clock and External Reference Clock In

Source	CLK IN (front panel SMB connector)
Input voltage range Sine wave 0.65 V _{pk-pk} to 2.8 V _{pk-pk} (0 dBm to 13 dBm) Square wave 0.2 V _{pk-pk} to 2.8 V _{pk-pk}	
Maximum input overload	7 V RMS with Peaks ≤10 V
Impedance	50 Ω
Coupling	AC

Trigger

Reference (Stop) Trigger

Trigger types ^[13]	Edge Window Hysteresis Video Digital Immediate Software
Trigger sources	CH 0 CH 1 TRIG PXI_Trig <0..6> PFI <0..1> PXI Star Trigger RTSI <0..6> Software
Time resolution Onboard clock, time-to-digital conversion circuit (TDC) on40 ps	

Onboard clock, TDC off		4 ns
External clock, TDC off		External clock period
Minimum rearm time^[14]		
TDC on		10 μ s
TDC off		2 μ s
Holdoff	From rearm time up to $[(2^{35} - 1) \times \text{Sample Clock Period}]$	
Trigger delay	From 0 up to $[(2^{35} - 1) - \text{Posttrigger Samples}] \times (1 / \text{Sample Rate})$, in seconds	

Analog Trigger

Trigger types	Edge
	Window
	Hysteresis
Sources	CH 0 (front panel BNC connector)
	CH 1 (front panel BNC connector)
	TRIG (front panel BNC connector)
Trigger level resolution	8 bits (1 in 256)
Trigger level range	
CH 0, CH 1	100% FS

TRIG (external trigger)	$\pm 5\text{ V}$
Edge trigger sensitivity	
CH 0, CH 1	5% FS up to 100 MHz, warranted
TRIG (external trigger)	0.5 V _{pk-pk} up to 125 MHz, warranted
Level accuracy	
CH 0, CH 1	$\pm 5\%$ FS up to 100 MHz
TRIG (external trigger)	$\pm 0.5\text{ V}$ up to 10 MHz
Jitter	$\leq 65\text{ ps RMS}$
Trigger filters	
Low frequency (LF) reject	50 kHz
High frequency (HF) reject	50 kHz

Digital Trigger

Trigger type	Digital
Sources	PXI_Trig <0..6> (backplane connector) PFI <0..1> (front panel 9-pin mini-circular DIN connector) PXI Star trigger (backplane connector)

Video Trigger

Trigger type	Video
Sources	CH 0 (front panel BNC connector) CH 1 (front panel BNC connector) TRIG (front panel BNC connector)
Video trigger types	Specific Line Any Line Specific Field
Standards^[15]	
SDTV	M-NTSC
	B/G-PAL
	SECAM
	M-PAL
EDTV	480i/59.94 fps
	480i/60 fps
	480p/59.94 Fps
	480p/60 Fps
	576i/50 fps
	576p/50 Fps

HDTV ^[16]	720p/50 Fps
	720p/59.94 Fps
	720p/60 Fps
	1080i/50 fps
	1080i/59.94 fps
	1080i/60 fps
	1080p/24 Fps

External Trigger

Connector	TRIG (front panel BNC connector)
Impedance	1 M Ω in parallel with 22 pF
Coupling	AC, DC
AC-coupling cutoff (-3 dB)	12 Hz
Input voltage range	± 5 V
Maximum input overload	Peaks ≤ 42 V

Programmable Function Interface (PFI 0 and PFI 1)

Connector	AUX I/O (front panel 9-pin mini-circular DIN connector)
Direction	Bidirectional

As an Input (Trigger)

Destinations	Start trigger (acquisition arm)
	Reference (Stop) trigger
	Arm reference trigger
	Advance trigger
Input impedance	150 k Ω , nominal
V_{IH}	2.0 V
V_{IL}	0.8 V
Maximum input overload	-0.5 V, 5.5 V
Maximum frequency	25 MHz

As an Output (Event)

Sources	Start trigger (acquisition arm)
	Reference (Stop) trigger
	End of Record
	Done (end of acquisition)
	Probe Compensation ^[17]
Output impedance	50 Ω
Logic type	3.3 V CMOS

Maximum drive current	±24 mA
Maximum frequency	25 MHz

Waveform

Onboard memory sizes ^[18]	8 MB per channel (standard) 64 MB per channel (option) 256 MB per channel (option)
Minimum record length	1 sample
Number of pretrigger samples ^[19]	Zero up to full record length
Number of posttrigger samples ^[19]	Zero up to full record length
Maximum number of records in onboard memory^[20]	
8 MB	32,768
64 MB	100,000
256 MB	100,000
Allocated onboard memory per record	(Record Length × 1 byte/sample) + 240 bytes, rounded up to next multiple of 128 bytes (minimum 256 bytes)

Calibration

External Calibration

External calibration calibrates the onboard references used in self-calibration and the external trigger levels. All calibration constants are stored in nonvolatile memory.

Self-Calibration

Self-calibration is done on software command. The calibration corrects for gain, offset, triggering, and timing errors for all input ranges.

Calibration Specifications

Interval for external calibration	2 years
Warm-up time ^[21]	15 minutes

Software

Driver Software

Driver support for this device was first available in NI-SCOPE 2.9.

NI-SCOPE is an IVI-compliant driver that allows you to configure, control, and calibrate the PXI-5114. NI-SCOPE provides application programming interfaces for many development environments.

Application Software

NI-SCOPE provides programming interfaces, documentation, and examples for the following application development environments:

- LabVIEW

- LabWindows™/CVI™
- Measurement Studio
- Microsoft Visual C/C++
- .NET (C# and VB.NET)

Interactive Soft Front Panel and Configuration

When you install NI-SCOPE on a 64-bit system, you can monitor, control, and record measurements from the PXI-5114 using InstrumentStudio.

InstrumentStudio is a software-based front panel application that allows you to perform interactive measurements on several different device types in a single program.



Note InstrumentStudio is supported only on 64-bit systems. If you are using a 32-bit system, use the NI-SCOPE-specific soft front panel instead of InstrumentStudio.

Interactive control of the PXI-5114 was first available via InstrumentStudio in NI-SCOPE 18.1 and via the NI-SCOPE SFP in NI-SCOPE 14.1. InstrumentStudio and the NI-SCOPE SFP are included on the NI-SCOPE media.

NI Measurement & Automation Explorer (MAX) also provides interactive configuration and test tools for the PXI-5114. MAX is included on the driver media.

TClk Specifications

You can use the NI TClk synchronization method and the NI-TClk driver to align the Sample clocks on any number of supported devices, in one or more chassis. For more information about TClk synchronization, refer to the **NI-TClk Synchronization Help**, which is located within the **NI High-Speed Digitizers Help**. For other configurations, including multichassis systems, contact NI Technical Support at ni.com/support.

Intermodule SMC Synchronization Using NI-TClk for Identical Modules

Specifications are valid for modules installed in one NI PXI-1042 chassis. These specifications do not apply to PCI modules. Specifications are valid under the following conditions:

- All parameters are set to identical values for each SMC-based module.
- Sample clock set to 250 MS/s.
- All filters are disabled.



Note Although you can use NI-TClk to synchronize non-identical modules, these specifications apply only to synchronizing identical modules.

Skew ^[22]	500 ps
Average skew after manual adjustment ^[23]	<20 ps
Sample clock adjustment resolution	<20 ps

Power

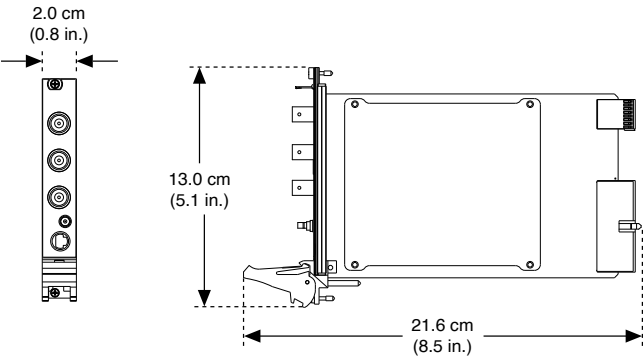
Current draw	
+3.3 VDC	840 mA
+5 VDC	1.1 A
+12 VDC	250 mA
-12 VDC	170 mA
Total power	13.32 W

Physical

Dimensions and Weight

Dimensions	3U, one-slot, PXI/cPCI module 21.6 cm × 2.0 cm × 13.0 cm (8.5 in × 0.8 in × 5.1 in)
Weight	455 g (16 oz)

Figure 1. PXI-5114



Front Panel

Label	Connector Type	Description
CH 0	BNC female	Analog input connection; digitizes data and triggers acquisitions.
CH 1		Analog input connection; digitizes data and triggers acquisitions.
TRIG		External analog trigger; signals on the TRIG connector cannot be digitized.
CLK IN	SMB jack	Imports an external Reference clock or Sample clock to the oscilloscope.
AUX I/O	9-pin mini-circular DIN	PFI 0 and PFI 1 lines for digital trigger input/output and probe compensation.

Table 3. PXI-5114 Front Panel Connectors

Label	Description
ACCESS	The ACCESS LED indicates the status of the PCI bus and the interface from the device to the controller.
ACTIVE	The ACTIVE LED indicates the status of the onboard acquisition hardware of the device.

Table 4. PXI-5114 Front Panel Indicators^[24]

Environment

Maximum altitude	2,000 m (at 25 °C ambient temperature)
Pollution Degree	2

Indoor use only.

Operating Environment

Ambient temperature range	0 °C to 55 °C (Tested in accordance with IEC 60068-2-1 and IEC 60068-2-2.)
Relative humidity range	10% to 90%, noncondensing (Tested in accordance with IEC 60068-2-56.)

Storage Environment

Ambient temperature range	-40 °C to 71 °C (Tested in accordance with IEC 60068-2-1 and IEC 60068-2-2.)
Relative humidity range	5% to 95%, noncondensing (Tested in accordance with IEC 60068-2-56.)

Shock and Vibration

Operational shock	30 g peak, half-sine, 11 ms pulse (Tested in accordance with IEC 60068-2-27. Test profile developed in accordance with MIL-PRF-28800F.)
Random vibration	
Operating	5 Hz to 500 Hz, 0.31 g _{rms} (Tested in accordance with IEC 60068-2-64.)
Nonoperating	5 Hz to 500 Hz, 2.46 g _{rms} (Tested in accordance with IEC 60068-2-64. Test profile exceeds the requirements of MIL-PRF-28800F, Class 3.)

Compliance and Certifications

Safety Compliance Standards

This product is designed to meet the requirements of the following electrical equipment safety standards for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1, CSA C22.2 No. 61010-1



Note For UL and other safety certifications, refer to the product label or the [Product Certifications and Declarations](#) section.

Electromagnetic Compatibility

This product meets the requirements of the following EMC standards for electrical equipment for measurement, control, and laboratory use:

- EN 61326-1 (IEC 61326-1): Class A emissions; Basic immunity
- EN 55011 (CISPR 11): Group 1, Class A emissions
- EN 55022 (CISPR 22): Class A emissions
- EN 55024 (CISPR 24): Immunity
- AS/NZS CISPR 11: Group 1, Class A emissions

- AS/NZS CISPR 22: Class A emissions
- FCC 47 CFR Part 15B: Class A emissions
- ICES-001: Class A emissions



Note In the United States (per FCC 47 CFR), Class A equipment is intended for use in commercial, light-industrial, and heavy-industrial locations. In Europe, Canada, Australia, and New Zealand (per CISPR 11), Class A equipment is intended for use only in heavy-industrial locations.



Note Group 1 equipment (per CISPR 11) is any industrial, scientific, or medical equipment that does not intentionally generate radio frequency energy for the treatment of material or inspection/analysis purposes.



Note For EMC declarations, certifications, and additional information, refer to the [Product Certifications and Declarations](#) section.

CE Compliance

This product meets the essential requirements of applicable European Directives, as follows:

- 2014/35/EU; Low-Voltage Directive (safety)
- 2014/30/EU; Electromagnetic Compatibility Directive (EMC)
- 2011/65/EU; Restriction of Hazardous Substances (RoHS)

Product Certifications and Declarations

Refer to the product Declaration of Conformity (DoC) for additional regulatory compliance information. To obtain product certifications and the DoC for NI products, visit ni.com/product-certifications, search by model number, and click the appropriate link.

Environmental Management

NI is committed to designing and manufacturing products in an environmentally responsible manner. NI recognizes that eliminating certain hazardous substances from our products is beneficial to the environment and to NI customers.

For additional environmental information, refer to the **Commitment to the Environment** web page at ni.com/environment. This page contains the environmental regulations and directives with which NI complies, as well as other environmental information not included in this document.

Waste Electrical and Electronic Equipment (WEEE)

EU Customers At the end of the product life cycle, all NI products must be disposed of according to local laws and regulations. For more information about how to recycle NI products in your region, visit ni.com/environment/weee.

电子信息产品污染控制管理办法 (中国 RoHS)

中国客户 National Instruments 符合中国电子信息产品中限制使用某些有害物质指令(RoHS)。关于 National Instruments 中国 RoHS 合规性信息，请登录 ni.com/environment/rohs_china。(For information about China RoHS compliance, go to ni.com/environment/rohs_china.)

¹ AC coupling available on 1 M Ω input only.

² Within ± 5 °C of self-calibration temperature.

³ CH 0 to/from CH 1, and External Trigger to CH 0 or CH 1

⁴ AC coupling available on 1 M Ω input only.

⁵ Referenced to 50 kHz, with bandwidth-limiting filter disabled.

⁶ 10 MHz, 10 MHz - 1 dBFS input signal. Includes the second through the fifth harmonics. Measured from DC to 125 MHz, with the 20 MHz bandwidth-limiting filter disabled. ENOB values are corrected to full scale.

⁷ Verified using a 50 Ω terminator connected to input.

⁸ Internal Sample clock is locked to the Reference clock or derived from the onboard VCXO.

⁹ Divide by **n** sampling used for all rates less than 250 MS/s. For more information about the Sample clock and decimation, refer to the [NI High-Speed Digitizers Help](#).

¹⁰ When not using external Sample clock.

¹¹ Divide by **n** decimation available where $1 \leq n \leq 65,535$. For more information about the Sample clock and decimation, refer to the [NI High-Speed Digitizers Help](#).

¹² The PLL Reference clock frequency must be accurate to ± 50 ppm.

¹³ Refer to the following sources and the **NI High-Speed Digitizers Help** for more information about which sources are available for each trigger type.

¹⁴ Holdoff set to 0. Onboard Sample clock at maximum rate.

¹⁵ fps = fields per second. Fps = frames per second.

¹⁶ This trigger type does not support negative trigger polarity.

¹⁷ 1 kHz, 50% duty cycle square wave, PFI 1 only.

¹⁸ Onboard memory is shared between enabled channels.

¹⁹ Single-record and multirecord acquisitions.

²⁰ You can exceed these numbers if you fetch records while acquiring data. For more information, refer to the [NI High-Speed Digitizers Help](#).

²¹ Warm-up time begins after the NI-SCOPE driver is loaded.

²² Caused by clock and analog path delay differences. No manual adjustment performed.

²³ For more information about manual adjustment, refer to the **Synchronization Repeatability Optimization** topic in the **NI-TClk Synchronization Help**.

²⁴ For more information, refer to the [NI High-Speed Digitizers Help](#).